



Welcome to [E-XFL.COM](https://www.e-xfl.com)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	ARM® Cortex®-M4F
Core Size	32-Bit Single-Core
Speed	200MHz
Connectivity	CANbus, CSIO, EBI/EMI, Ethernet, I ² C, LINbus, SD, SPI, UART/USART, USB
Peripherals	DMA, I ² S, LVD, POR, PWM, WDT
Number of I/O	152
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 32x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	176-LQFP
Supplier Device Package	176-LQFP (24x24)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/s6e2ccaj0agv2000a

Pin Number				Pin Name	I/O Circuit Type	Pin State Type
LQQ216	LQP176	LQS144	LBE192			
57	47	39	N3	P41	G	I
				SOT3_1 (SDA3_1)		
				RTO11_0 (PPG10_0)		
				TIOA1_0		
				BIN0_0		
				MCSX6_0		
58	48	40	M3	P42	G	I
				SCK3_1 (SCL3_1)		
				RTO12_0 (PPG12_0)		
				TIOA2_0		
				ZIN0_0		
				MCSX5_0		
59	49	41	L4	P43	G	K
				SIN15_0		
				RTO13_0 (PPG12_0)		
				TIOA3_0		
				INT04_0		
				MCSX4_0		
60	50	42	M4	P44	G	I
				SOT15_0 (SDA15_0)		
				RTO14_0 (PPG14_0)		
				TIOA4_0		
				MCSX3_0		
61	51	43	N4	P45	G	I
				SCK15_0 (SCL15_0)		
				RTO15_0 (PPG14_0)		
				TIOA5_0		
				MCSX2_0		
62	52	44	P2	C	-	-
63	53	45	P3	VSS	-	-
64	54	46	P4	VCC	-	-
65	-	-	-	P4A	E	K
				SIN12_1		
				AIN0_1		
				INT04_2		
66	-	-	-	P4B	E	I
				SOT12_1 (SDA12_1)		
				BIN0_1		
67	-	-	-	P4C	E	I
				SCK12_1 (SCL12_1)		
				ZIN0_1		
68	-	-	-	P4D	E	K
				SCS72_1		
				RX2_2		
				INT05_2		

Pin Number				Pin Name	I/O Circuit Type	Pin State Type
LQQ216	LQP176	LQS144	LBE192			
69	-	-	-	P4E	E	I
				SCS73_1		
				TX2_2		
70	55	47	L5	P7D	L	Q
				SCK1_1 (SCL1_1)		
				RX2_0		
				DTT1X_0		
				INT05_0		
				WKUP2		
				MCSX1_0		
71	56	48	M5	P7E	L	I
				ADTG_7		
				TX2_0		
				FRCK1_0		
				MCSX0_0		
72	57	49	N5	INITX	B	C
73	58	50	P5	P46	P	S
				X0A		
74	59	51	P6	P47	Q	T
				X1A		
75	60	52	P8	VBAT	-	-
76	61	53	N6	P48	O	U
				VREGCTL		
77	62	54	M6	P49	O	U
				VWAKEUP		
78	63	-	K5	PF0	E	K
				SCS63_0		
				RX2_1		
				FRCK1_1		
				TIOA15_1		
				INT22_1		
79	64	-	K6	PF1	E	K
				SCS62_0		
				TX2_1		
				TIOB15_1		
				INT23_1		
80	65	55	L6	P70	I	K
				ADTG_8		
				SIN1_1		
				INT06_0		
				MRDY_0		
81	66	56	J6	P71	E	I
				SOT1_1 (SDA1_1)		
				MAD00_0		
82	67	57	L8	P72	E	K
				SIN9_0		
				TIOB0_0		
				INT07_0		
				MAD01_0		
83	68	58	K8	P73	E	I
				SOT9_0 (SDA9_0)		
				TIOB1_0		
				MAD02_0		

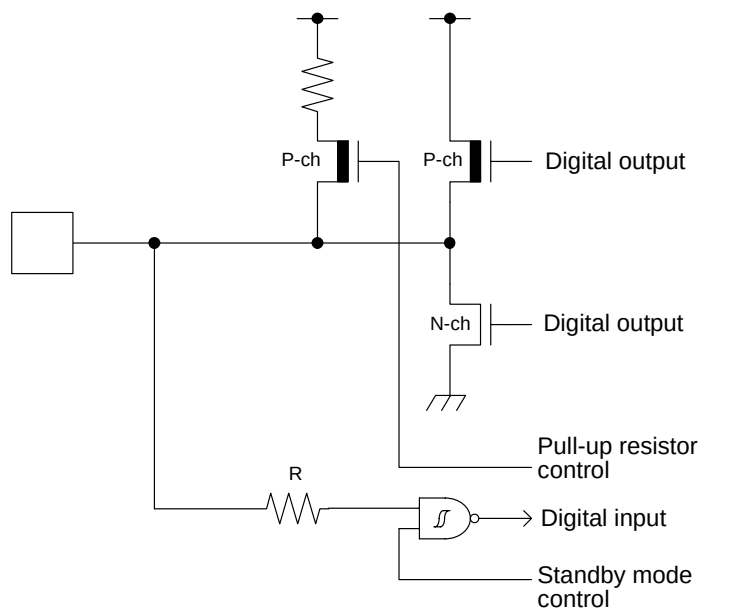
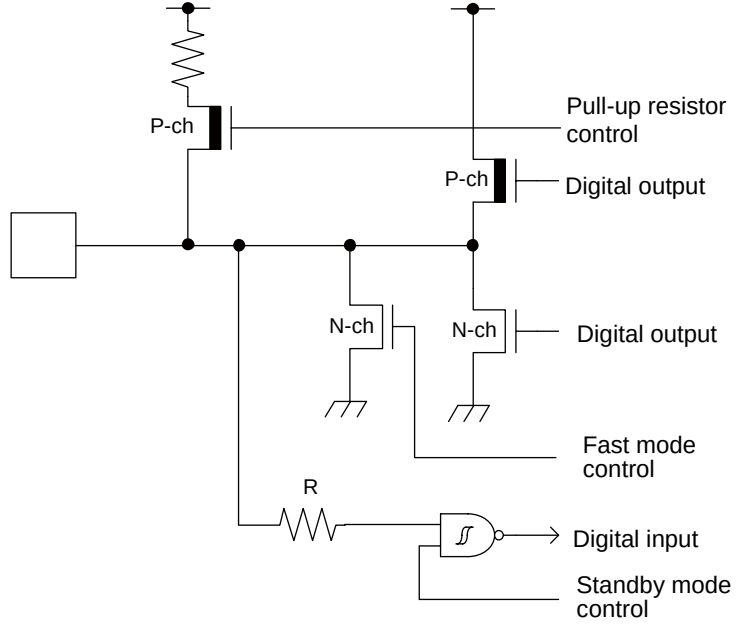
Pin Number				Pin Name	I/O Circuit Type	Pin State Type
LQQ216	LQP176	LQS144	LBE192			
172	142	-	C10	P93	S	K
				SCK5_1		
				(SCL5_1)		
				INT15_1		
173	143	-	D10	Q_IO0_0	S	I
				P94		
				CTS5_1		
				Q_SCK_0		
174	144	-	B9	P95	S	I
				RTS5_1		
				Q_CS0_0		
				P96		
175	-	-	-	RX0_2	S	K
				INT12_2		
				Q_CS1_0		
				P97		
176	-	-	-	TX0_2	S	K
				INT13_2		
				Q_CS2_0		
				PC0		
177	145	115	C9	E_RXER	K	V
				PC1		
				TIOB6_0		
				E_RX03		
178	146	116	B8	PC2	K	V
				TIOA6_0		
				E_RX02		
				PC3		
179	147	117	D9	TIOB7_0	K	V
				E_RX01		
				PC4		
				TIOA7_0		
180	148	118	E9	E_RX00	K	V
				PC5		
				TIOB14_0		
				E_RXDV		
181	149	119	F9	PC6	K	V
				TIOA14_0		
				E_MDIO		
				PC7		
182	150	120	C8	INT13_0	E	W
				E_MDC		
				CROUT_1		
				PC8		
183	151	121	D8	E_RXCK REFCK	K	V
				PC9		
				TIOB15_0		
				E_COL		
184	152	122	E8	PCA	K	V
				TIOA15_0		
				E_CRS		
				ETHVCC		
185	153	123	A10	VSS	-	-
186	154	124	F8		-	-
187	155	125	B7		-	-
188	156	126	A9		-	-
189	157	127	A8		-	-

Module	Pin Name	Function	Pin Number			
			LQQ 216	LQP 176	LQS 144	LBE 192
Base Timer 0	TIOA0_0	Base Timer ch 0 TIOA pin	56	46	38	N2
	TIOA0_1		45	35	30	J2
	TIOA0_2		114	94	78	L11
	TIOB0_0	Base Timer ch 0 TIOB pin	82	67	57	L8
	TIOB0_1		21	-	-	-
	TIOB0_2		115	95	79	K13
Base Timer 1	TIOA1_0	Base Timer ch 1 TIOA pin	57	47	39	N3
	TIOA1_1		46	36	31	K1
	TIOA1_2		116	96	80	K12
	TIOB1_0	Base Timer ch 1 TIOB pin	83	68	58	K8
	TIOB1_1		22	-	-	-
	TIOB1_2		123	99	83	J13
Base Timer 2	TIOA2_0	Base Timer ch 2 TIOA pin	58	48	40	M3
	TIOA2_1		47	37	32	K2
	TIOA2_2		124	100	84	J12
	TIOB2_0	Base Timer ch 2 TIOB pin	84	69	59	J8
	TIOB2_1		26	-	-	-
	TIOB2_2		125	101	85	J11
Base Timer 3	TIOA3_0	Base Timer ch 3 TIOA pin	59	49	41	L4
	TIOA3_1		48	38	33	K3
	TIOA3_2		130	106	86	H9
	TIOB3_0	Base Timer ch 3 TIOB pin	91	76	60	K9
	TIOB3_1		27	-	-	-
	TIOB3_2		131	107	87	H12
Base Timer 4	TIOA4_0	Base Timer ch 4 TIOA pin	60	50	42	M4
	TIOA4_1		49	39	34	K4
	TIOA4_2		132	108	88	H14
	TIOB4_0	Base Timer ch 4 TIOB pin	92	77	61	P10
	TIOB4_1		28	-	-	-
	TIOB4_2		133	109	89	G14
Base Timer 5	TIOA5_0	Base Timer ch 5 TIOA pin	61	51	43	N4
	TIOA5_1		50	40	35	L1
	TIOA5_2		134	110	90	H13
	TIOB5_0	Base Timer ch 5 TIOB pin	93	78	62	N10
	TIOB5_1		29	-	-	-
	TIOB5_2		135	111	91	H11
Base Timer 6	TIOA6_0	Base Timer ch 6 TIOA pin	179	147	117	D9
	TIOA6_1		85	70	-	N8
	TIOA6_2		200	-	-	-
	TIOB6_0	Base Timer ch 6 TIOB pin	178	146	116	B8
	TIOB6_1		86	71	-	M8
	TIOB6_2		199	-	-	-

Module	Pin Name	Function	Pin Number			
			LQQ 216	LQP 176	LQS 144	LBE 192
Base Timer 13	TIOA13_0	Base Timer ch 13 TIOA pin	7	7	7	D1
	TIOA13_1		154	124	100	E12
	TIOA13_2		34	24	-	G6
	TIOB13_0	Base Timer ch 13 TIOB pin	31	22	19	G4
	TIOB13_1		155	125	101	E13
	TIOB13_2		35	25	-	H4
Base Timer 14	TIOA14_0	Base Timer ch 14 TIOA pin	183	151	121	D8
	TIOA14_1		89	74	-	M9
	TIOA14_2		204	-	-	-
	TIOB14_0	Base Timer ch 14 TIOB pin	182	150	120	C8
	TIOB14_1		90	75	-	L9
	TIOB14_2		203	-	-	-
Base Timer 15	TIOA15_0	Base Timer ch 15 TIOA pin	187	155	125	B7
	TIOA15_1		78	63	-	K5
	TIOA15_2		206	-	-	-
	TIOB15_0	Base timer ch 15 TIOB pin	186	154	124	F8
	TIOB15_1		79	64	-	K6
	TIOB15_2		205	-	-	-
CAN 0	TX0_0	CAN interface ch 0 TX output pin	18	17	14	F4
	TX0_1		35	25	-	H4
	TX0_2		176	-	-	-
	RX0_0	CAN interface ch 0 RX output pin	17	16	13	F3
	RX0_1		34	24	-	G6
	RX0_2		175	-	-	-
CAN 1	TX1_0	CAN interface ch 1 TX output pin	152	122	98	E10
	TX1_1		118	98	82	K11
	TX1_2		148	-	-	-
	RX1_0	CAN interface ch 1 RX output pin	153	123	99	E11
	RX1_1		117	97	81	K14
	RX1_2		149	-	-	-
CAN 2 (CAN-FD)	TX2_0	CAN-FD interface ch 2 TX output pin	71	56	48	M5
	TX2_1		79	64	-	K6
	TX2_2		69	-	-	-
	RX2_0	CAN-FD interface ch 2 RX input pin	70	55	47	L5
	RX2_1		78	63	-	K5
	RX2_2		68	-	-	-

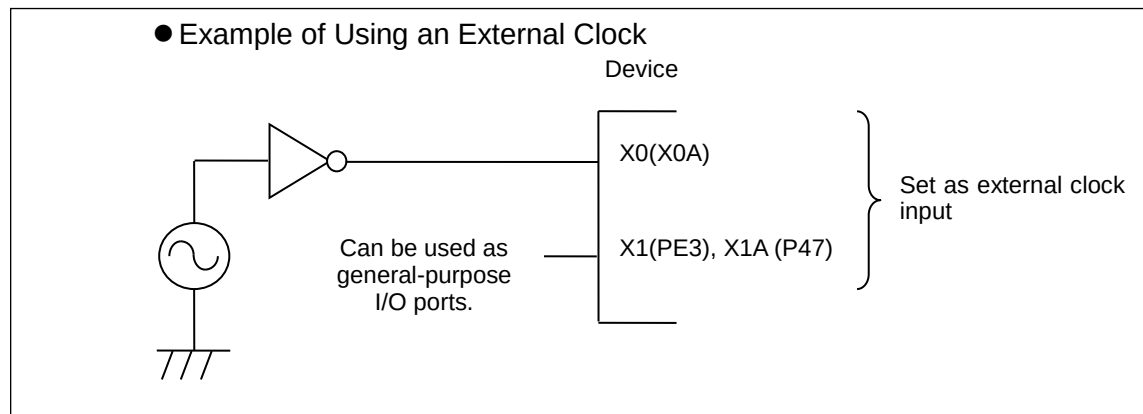
Module	Pin Name	Function	Pin Number			
			LQQ 216	LQP 176	LQS 144	LBE 192
Multi-Function Serial 7	SIN7_0	Multi-function serial interface ch 7 input pin	14	13	10	E5
	SIN7_1		103	-	-	-
	SOT7_0 (SDA7_0)	Multi-function serial interface ch 7 output pin	15	14	11	F1
	SOT7_1 (SDA7_1)	This pin operates as SOT7 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA7 when it is used in an I ² C (operation mode 4).	102	-	-	-
	SCK7_0 (SCL7_0)	Multi-function serial interface ch 7 clock I/O pin	16	15	12	F2
	SCK7_1 (SCL7_1)	This pin operates as SCK7 when it is used in a CSIO (operation mode 2) and as SCL7 when it is used in an I ² C (operation mode 4).	101	-	-	-
	SCS70_0	Multi-function serial interface ch 7 chip select 0 input/output pin	17	16	13	F3
	SCS70_1		94	-	-	-
	SCS71_0	Multi-function serial interface ch 7 chip select 1 input/output pin	18	17	14	F4
	SCS71_1		95	-	-	-
	SCS72_0	Multi-function serial interface ch 7 chip select 2 input/output pin	10	10	-	E2
	SCS72_1		68	-	-	-
	SCS73_0	Multi-function serial interface ch 7 chip select 3 input/output pin	11	11	-	E3
	SCS73_1		69	-	-	-
Multi-Function Serial 8	SIN8_0	Multi-function serial interface ch 8 input pin	91	76	60	K9
	SIN8_1		138	112	-	G13
	SOT8_0 (SDA8_0)	Multi-function serial interface ch 8 output pin	92	77	61	P10
	SOT8_1 (SDA8_1)	This pin operates as SOT8 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA8 when it is used in an I ² C (operation mode 4).	139	113	-	F14
	SCK8_0 (SCL8_0)	Multi-function serial interface ch 8 clock I/O pin	93	78	62	N10
	SCK8_1 (SCL8_1)	This pin operates as SCK8 when it is used in a CSIO (operation mode 2) and as SCL8 when it is used in an I ² C (operation mode 4).	140	114	-	G12
Multi-Function Serial 9	SIN9_0	Multi-function serial interface ch 9 input pin	82	67	57	L8
	SIN9_1		120	-	-	-
	SOT9_0 (SDA9_0)	Multi-function serial interface ch 9 output pin	83	68	58	K8
	SOT9_1 (SDA9_1)	This pin operates as SOT9 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA9 when it is used in an I ² C (operation mode 4).	121	-	-	-
	SCK9_0 (SCL9_0)	Multi-function serial interface ch 9 clock I/O pin	84	69	59	J8
	SCK9_1 (SCL9_1)	This pin operates as SCK9 when it is used in a CSIO (operation mode 2) and as SCL9 when it is used in an I ² C (operation mode 4).	122	-	-	-

Module	Pin Name	Function	Pin Number			
			LQQ 216	LQP 176	LQS 144	LBE 192
Real-time clock	RTCCO_0	0.5 seconds pulse output pin of real-time clock	211	171	139	C4
	RTCCO_1		33	-	-	-
	SUBOUT_0	Sub-clock output pin	211	171	139	C4
	SUBOUT_1		33	-	-	-
USB0	UDM0	USB ch 0 device/host D – pin	214	174	142	A3
	UDP0	USB ch 0 device/host D + pin	215	175	143	A2
	UHCONX0	USB ch 0 external pull-up control pin	211	171	139	C4
USB1	UDM1	USB ch 1 device/host D – pin	160	130	106	D14
	UDP1	USB ch 1 device/host D + pin	161	131	107	C14
	UHCONX1	USB ch 1 external pull-up control pin	155	125	101	E13
Low power Consumption mode	WKUP0	Deep Standby mode return signal input pin 0	158	128	104	C13
	WKUP1	Deep Standby mode return signal input pin 1	14	13	10	E5
	WKUP2	Deep Standby mode return signal input pin 2	70	55	47	L5
	WKUP3	Deep Standby mode return signal input pin 3	212	172	140	B3
D/A converter	DA0	D/A converter ch 0 analog output pin	100	83	67	M11
	DA1	D/A converter ch 1 analog output pin	99	82	66	N11
VBAT	VREGCTL	On-board regulator control pin	76	61	53	N6
	VWAKEUP	The return signal input pin from a hibernation state	77	62	54	M6
SD I/F	S_CLK_0	SD memory card interface SD memory card clock output pin	38	28	23	H3
	S_CMD_0	SD memory card interface SD memory card command output	41	31	26	H6
	S_DATA1_0	SD memory card interface SD memory card data bus	36	26	21	H2
	S_DATA0_0		37	27	22	J1
	S_DATA3_0		42	32	27	J5
	S_DATA2_0		43	33	28	J4
	S_CD_0	SD memory card interface SD memory card detection pin	45	35	30	J2
	S_WP_0	SD memory card interface SD memory card write protection	44	34	29	J3

Type	Circuit	Remarks
L		• CMOS level output • CMOS level hysteresis input • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -8 \text{ mA}$, $I_{OL} = 8 \text{ mA}$ • When this pin is used as an I²C pin, the digital output P-ch transistor is always off.
N		• CMOS level output • CMOS level hysteresis input • 5V tolerant • Pull-up resistor control • Standby mode control • Pull-up resistor: approximately 50 kΩ • $I_{OH} = -4 \text{ mA}$, $I_{OL} = 4 \text{ mA}$ (GPIO) • $I_{OL} = 20 \text{ mA}$ (Fast mode Plus) • Available to control of PZR register (pseudo-open drain control) • For PZR registers, refer to GPIO in the FM4 Family Peripheral Manual Main Part (002-04857). • When this pin is used as an I²C pin, the digital output P-ch transistor is always off.

Using an External Clock

When using an external clock as an input of the main clock, set X0/X1 to the external clock input, and input the clock to X0. X1(PE3) can be used as a general-purpose I/O port. Similarly, when using an external clock as an input of the sub clock, set X0A/X1A to the external clock input and input the clock to X0A. X1A (P47) can be used as a general-purpose I/O port.

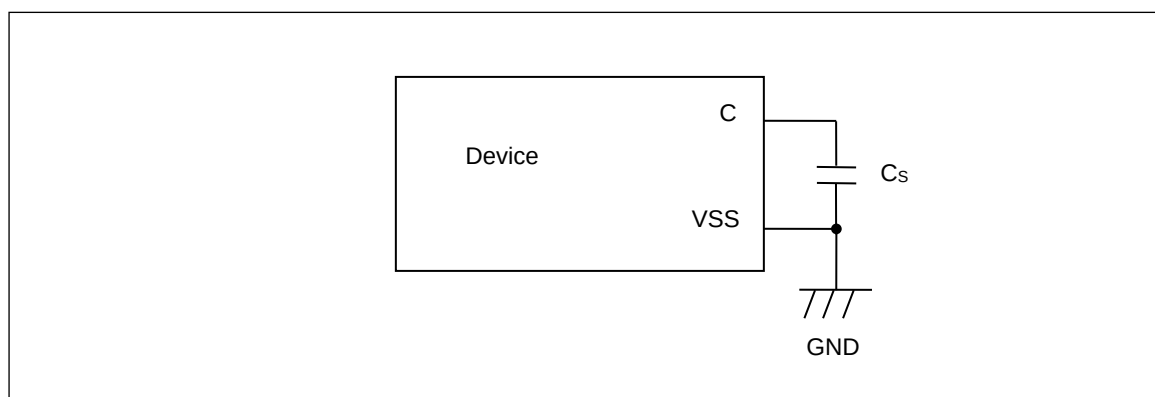


Handling When Using Multi-Function Serial Pin As I²C Pin

If the application uses the multi-function serial pin as an I²C pin, the P-channel transistor of the digital output must be disabled. I²C pins need to conform to electrical limitations like other pins, however, and avoid connecting to live external systems with the MCU power off.

C Pin

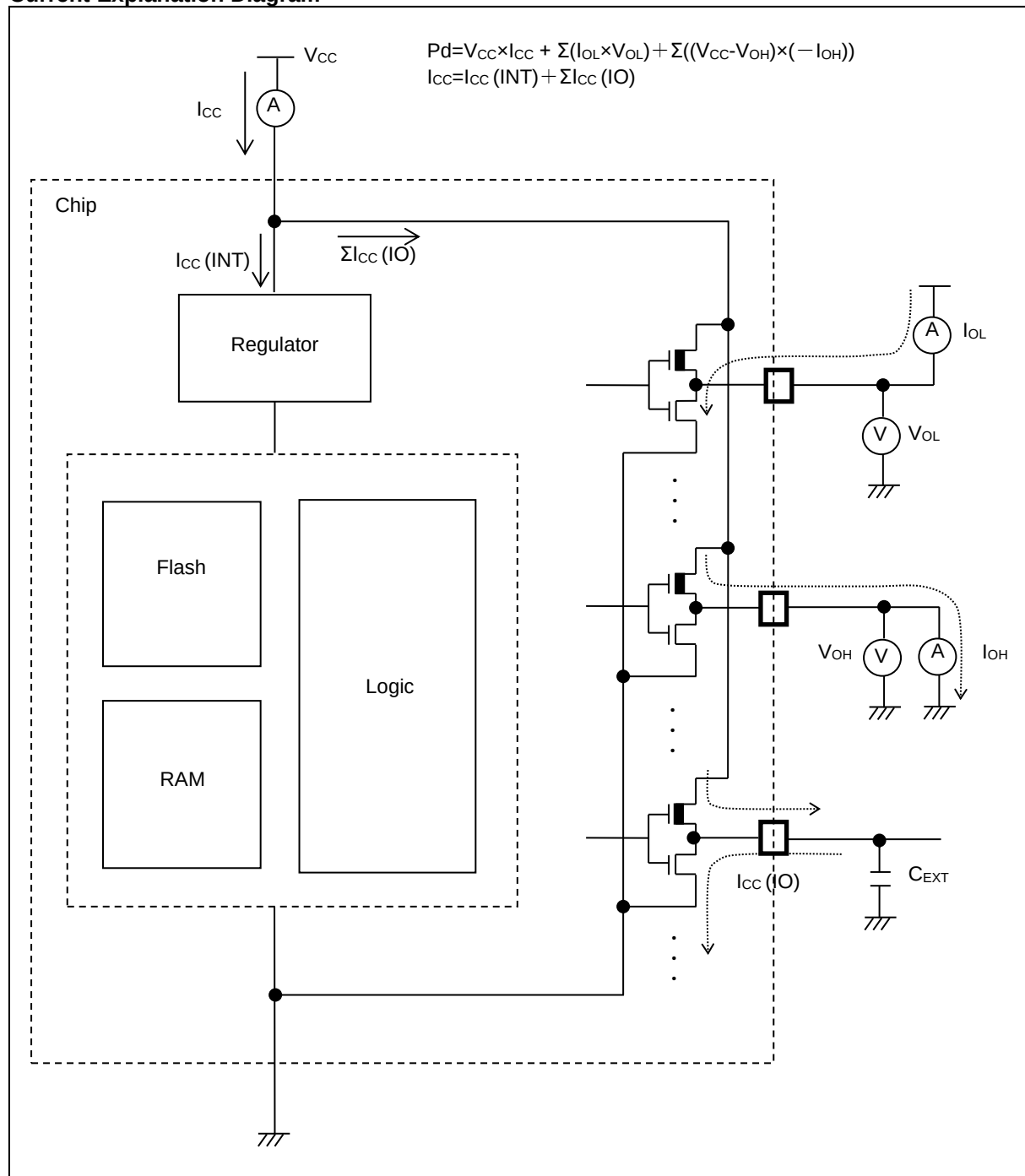
Devices in this series contain a regulator. Be sure to connect a smoothing capacitor (C_s) for the regulator between the C pin and the GND pin. Please use a ceramic capacitor or a capacitor of equivalent frequency characteristics as a smoothing capacitor. Some laminated ceramic capacitors have a large capacitance variation due to thermal fluctuation. Please select a capacitor that meets the specifications in the operating conditions to use by evaluating the temperature characteristics of the device. A smoothing capacitor of about 4.7 μ F would be recommended for this series.

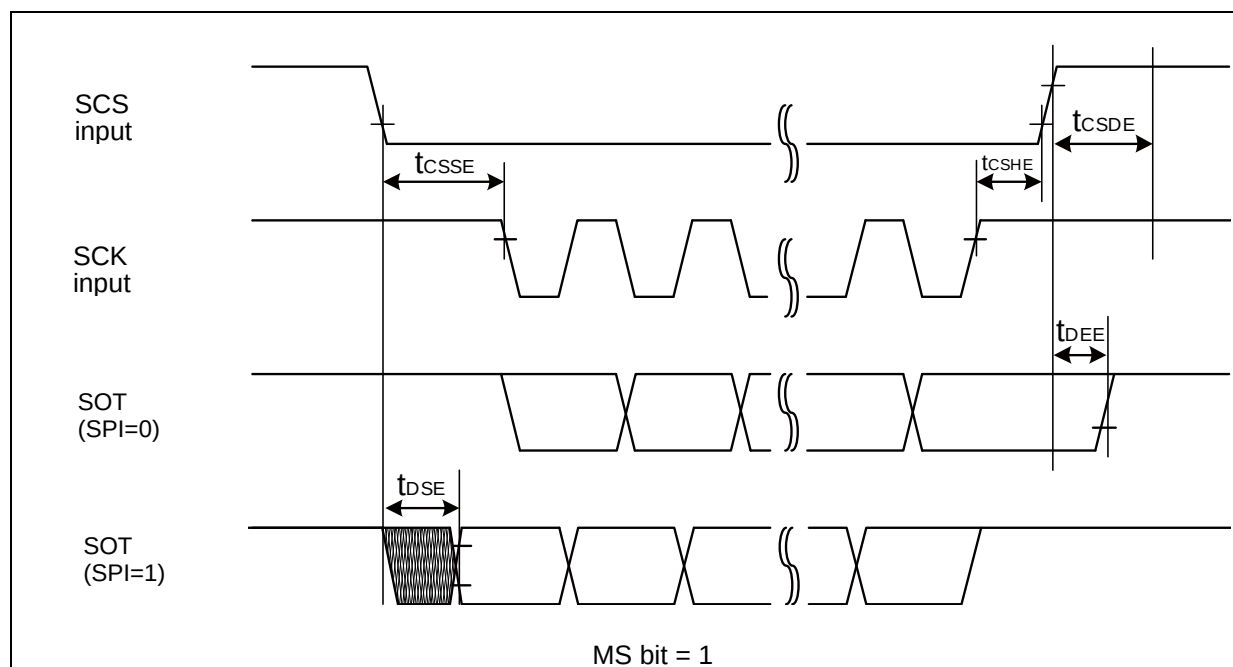
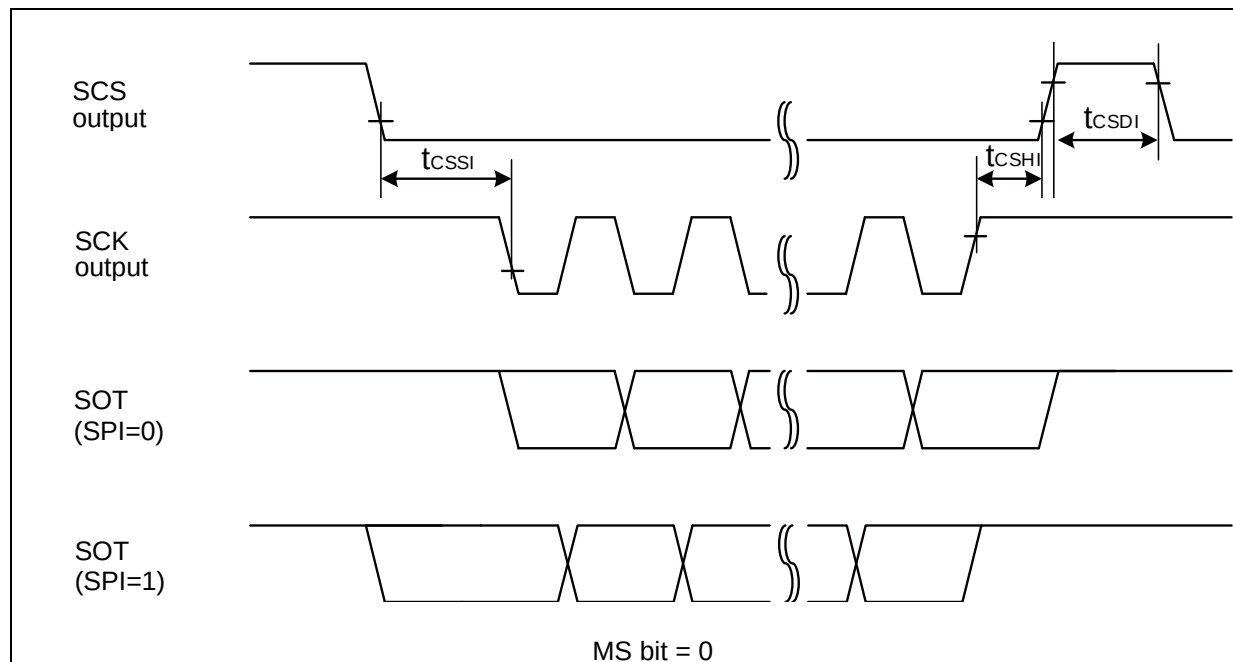


Mode Pins (MD0)

Connect the MD pin (MD0) directly to VCC or VSS pins. Design the printed circuit board such that the pull-up/down resistance stays low, the distance between the mode pins and VCC pins or VSS pins is as short as possible, and the connection impedance is low when the pins are pulled up/down such as for switching the pin level and rewriting the flash memory data. This is important to prevent the device from erroneously switching to test mode as a result of noise.

Current Explanation Diagram





When Using Synchronous Serial Chip Select (SCINV = 1, CSLVL = 1)

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Conditions	V _{CC} < 4.5 V		V _{CC} ≥ 4.5 V		Unit
			Min	Max	Min	Max	
SCS↓→SCK↓ setup time	t _{CSSI}	Internal shift clock operation	(*1)-50	(*1)+0	(*1)-50	(*1)+0	ns
SCK↑→SCS↑ hold time	t _{CSHI}		(*2)+0	(*2)+50	(*2)+0	(*2)+50	ns
SCS deselect time	t _{CSDI}		(*3)-50 +5t _{CYCP}	(*3)+50 +5t _{CYCP}	(*3)-50 +5t _{CYCP}	(*3)+50 +5t _{CYCP}	ns
SCS↓→SCK↓ setup time	t _{CSSE}	External shift clock operation	3t _{CYCP} +30	-	3t _{CYCP} +30	-	ns
SCK↑→SCS↑ hold time	t _{CSHE}		0	-	0	-	ns
SCS deselect time	t _{CSDE}		3t _{CYCP} +30	-	3t _{CYCP} +30	-	ns
SCS ↓ →SOT delay time	t _{DSE}		-	40	-	40	ns
SCS ↑ →SOT delay time	t _{DEE}		0	-	0	-	ns

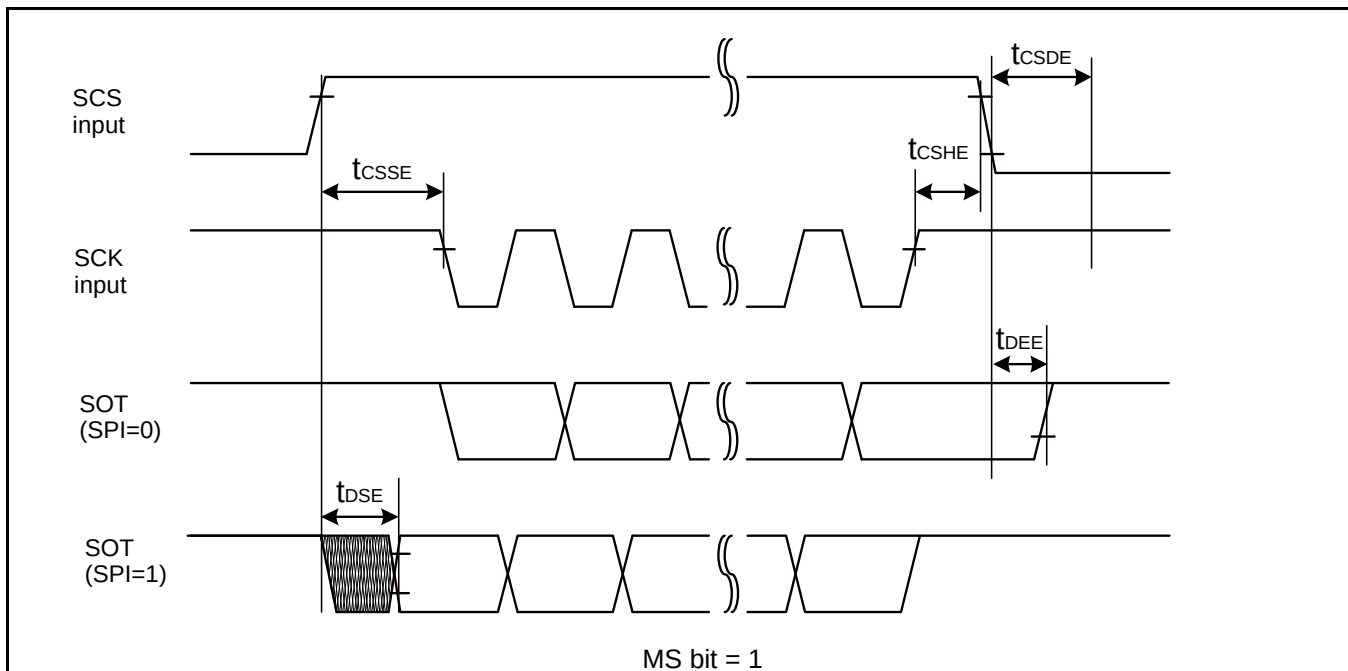
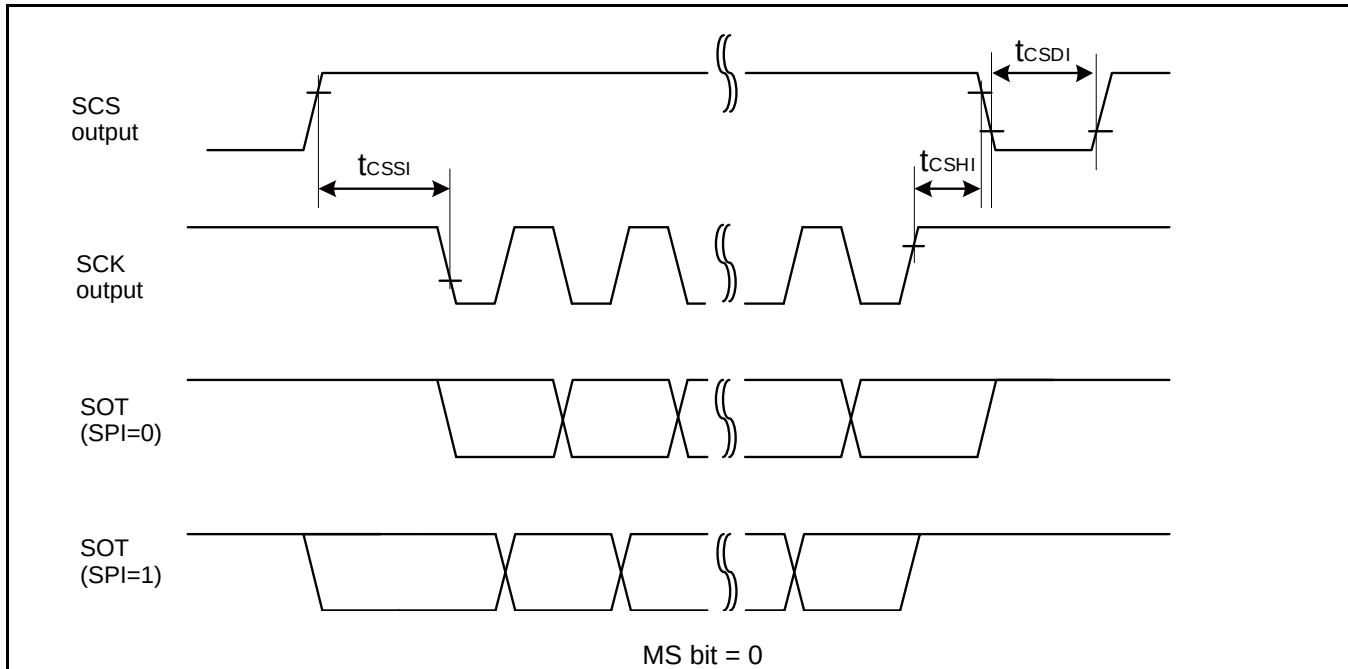
(*1): CSSU bit value×serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value×serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value×serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.



When Using High-Speed Synchronous Serial Chip Select (SCINV = 1, CSLVL = 1)

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V)

Parameter	Symbol	Conditions	V _{CC} < 4.5 V		V _{CC} ≥ 4.5 V		Unit
			Min	Min	Min	Max	
SCS↓→SCK↓ setup time	t _{CSSI}	Internal shift clock operation	(*1)-20	(*1)+0	(*1)-20	(*1)+0	ns
SCK↑→SCS↑ hold time	t _{CSHI}		(*2)+0	(*2)+20	(*2)+0	(*2)+20	ns
SCS deselect time	t _{CSDI}		(*3)-20 +5t _{CYCP}	(*3)+20 +5t _{CYCP}	(*3)-20 +5t _{CYCP}	(*3)+20 +5t _{CYCP}	ns
SCS↓→SCK↑ setup time	t _{CSSE}	External shift clock operation	3t _{CYCP} +15	-	3t _{CYCP} +15	-	ns
SCK↑→SCS↑ hold time	t _{CSHE}		0	-	0	-	ns
SCS deselect time	t _{CSDE}		3t _{CYCP} +15	-	3t _{CYCP} +15	-	ns
SCS↓→SOT delay time	t _{DSE}		-	25	-	25	ns
SCS↑→SOT delay time	t _{DEE}		0	-	0	-	ns

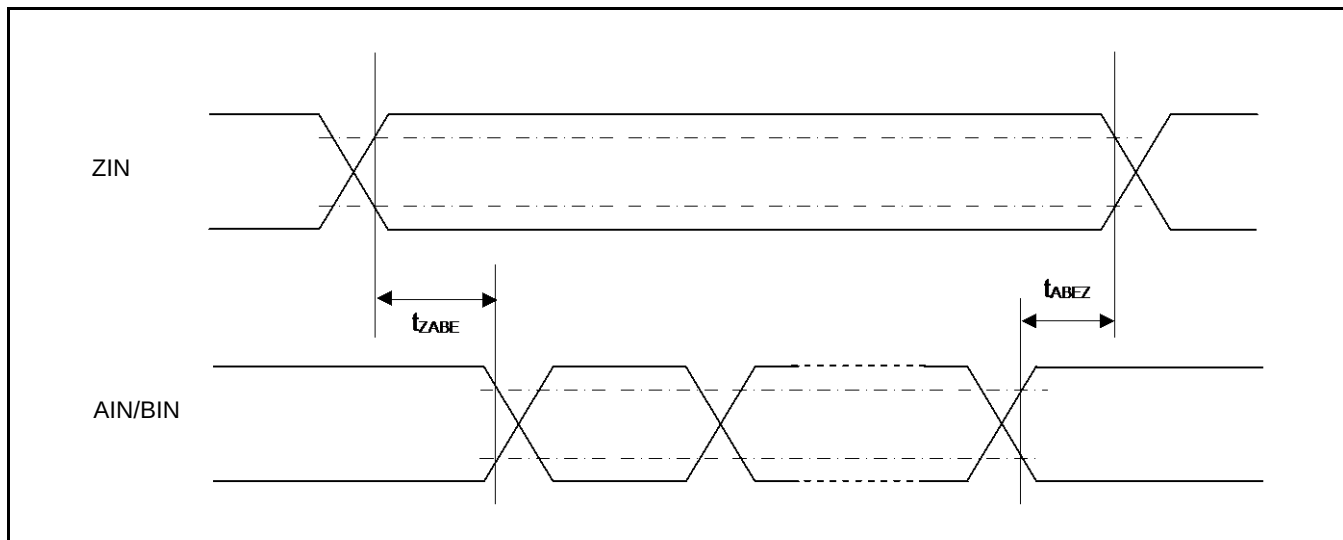
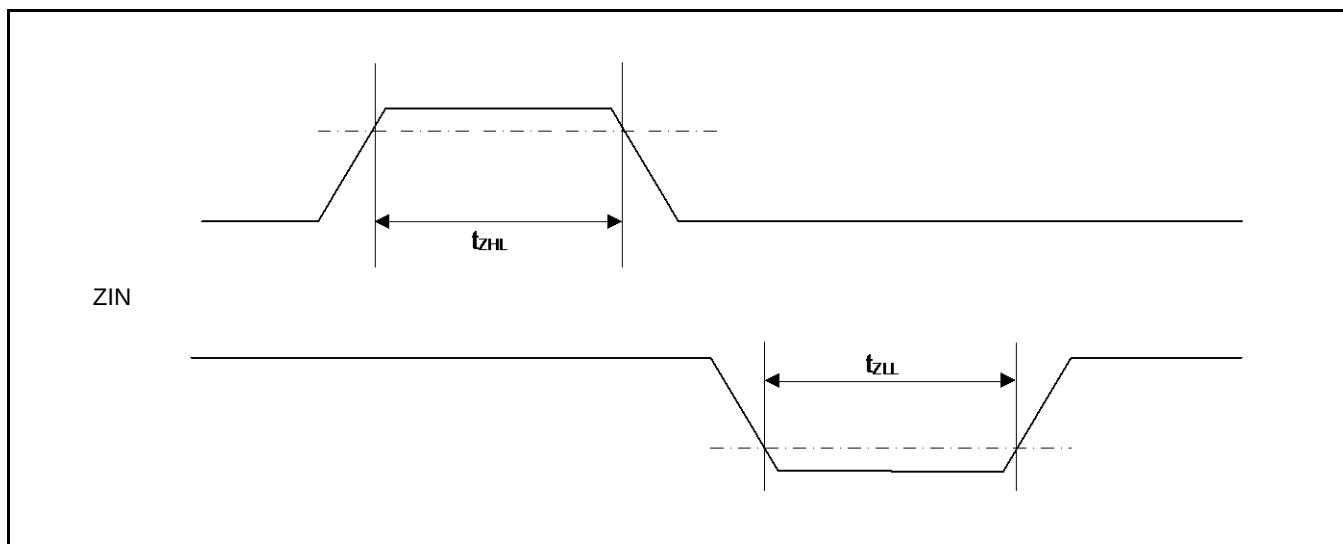
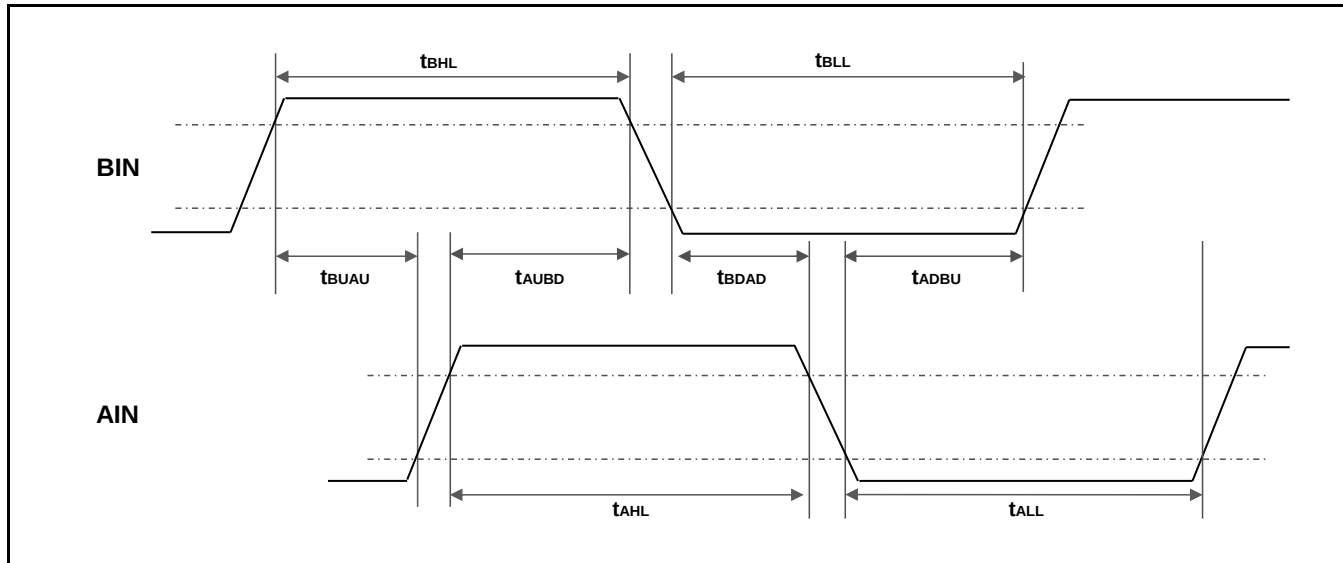
(*1): CSSU bit value×serial chip select timing operating clock cycle [ns]

(*2): CSHD bit value×serial chip select timing operating clock cycle [ns]

(*3): CSDS bit value×serial chip select timing operating clock cycle [ns]

Notes:

- t_{CYCP} indicates the APB bus clock cycle time. For more information about the APB bus number to which the multi-function serial is connected, see 8. Block Diagram in this data sheet.
- For more information about CSSU, CSHD, CSDS, and the serial chip select timing operating clock, see FM4 Family Peripheral Manual Main Part (002-04856).
- When the external load capacitance C_L = 30 pF.



12.6 12-bit D/A Converter

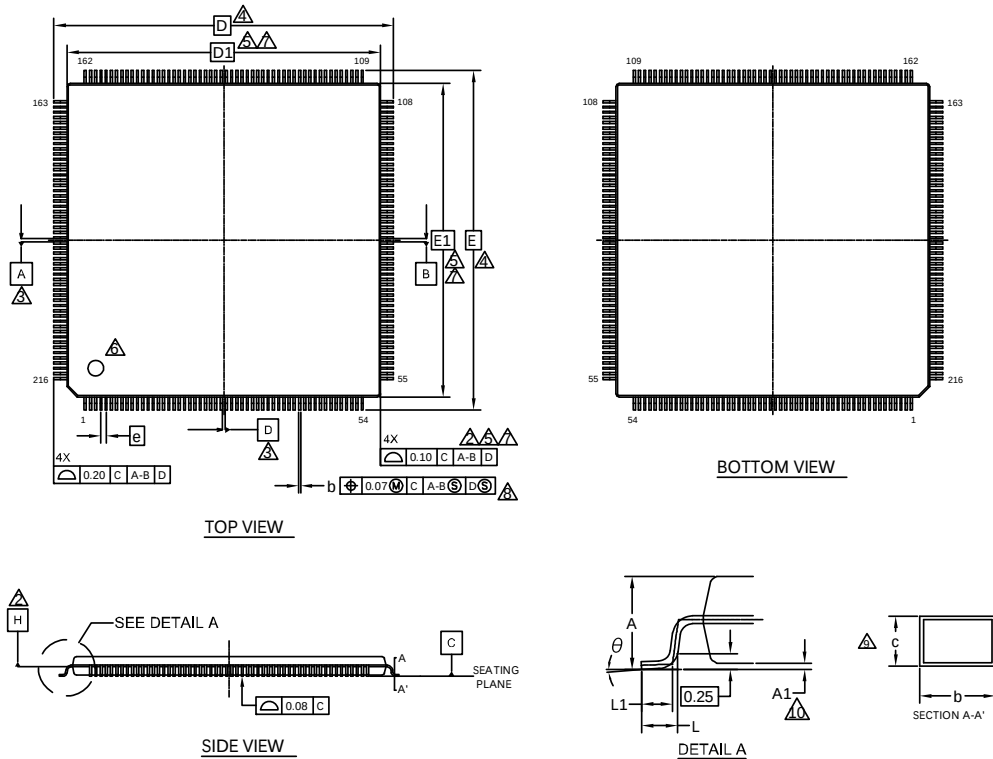
Electrical Characteristics for the D/A Converter

($V_{CC} = AV_{CC} = 2.7V$ to $5.5V$, $V_{SS} = AV_{SS} = 0V$)

Parameter	Symbol	Pin Name	Value			Unit	Remarks
			Min	Typ	Max		
Resolution	-	DAx	-	-	12	bit	
Conversion time	t _{C20}		0.56	0.69	0.81	μs	Load 20 pF
	t _{C100}		2.79	3.42	4.06	μs	Load 100 pF
Integral nonlinearity*	INL		- 16	-	+ 16	LSB	
Differential nonlinearity*	DNL		- 0.98	-	+ 1.5	LSB	
Output voltage offset	V _{OFF}		-	-	+ 10	mV	When setting 0x000
			- 20.0	-	+ 1.4	mV	When setting 0xFFFF
Analog output impedance	R _O		3.10	3.80	4.50	kΩ	D/A operation
		2.0	-	-	MΩ	When D/A stop	
Power supply current*	IDDA	AVCC	260	330	410	μs	D/A 1ch operation AV _{CC} = 3.3 V
			400	510	620	μs	D/A 1ch operation AV _{CC} = 5.0 V
	IDSA		-	-	14	μs	When D/A stop

*: During no load

Package Type	Package Code
LQFP 216	LQQ 216



SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	—	—	1.70
A1	0.05	—	0.15
b	0.13	0.18	0.23
c	0.09	—	0.20
D	26.00 BSC.		
D1	24.00 BSC.		
e	0.40 BSC.		
E	26.00 BSC.		
E1	24.00 BSC.		
L	0.45	0.60	0.75
L1	0.30	0.50	0.70
θ	0°	—	8°

NOTES

- ALL DIMENSIONS ARE IN MILLIMETERS.
- DATUM PLANE H IS LOCATED AT THE BOTTOM OF THE MOLD PARTING LINE COINCIDENT WITH WHERE THE LEAD EXITS THE BODY.
- DATUMS A-B AND D TO BE DETERMINED AT DATUM PLANE H.
- TO BE DETERMINED AT SEATING PLANE C.
- DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PRE SIDE. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE H.
- DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
- REGARDLESS OF THE RELATIVE SIZE OF THE UPPER AND LOWER BODY SECTIONS. DIMENSIONS D1 AND E1 ARE DETERMINED AT THE LARGEST FEATURE OF THE BODY EXCLUSIVE OF MOLD FLASH AND GATE BURRS. BUT INCLUDING ANY MISMATCH BETWEEN THE UPPER AND LOWER SECTIONS OF THE MOLDER BODY.
- DIMENSION b DOES NOT INCLUDE DAMBER PROTRUSION. THE DAMBAR PROTRUSION (S) SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED b MAXIMUM BY MORE THAN 0.08mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE LEAD FOOT.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm AND 0.25mm FROM THE LEAD TIP.
- A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

002-15153 **

PACKAGE OUTLINE, 216 LEAD LQFP
24.0X24.0X1.7 MM LQQ216 REV**

15. Major Changes

Spanson Publication Number: DS709-00009

Page	Section	Change Results
Revision 0.1		
-	-	Initial release
Revision 0.2		
1, 3	Title	Added the following products. S6E2CC8HHA/S6E2CC9HHA/S6E2CCAHHA/ S6E2CC8JHA/S6E2CC9JHA/S6E2CCAJHA/ S6E2CC8LHA/S6E2CC9LHA/S6E2CCALHA
14	2.Feature	Added "Crypto Assist Function"
16, 17	3.Product Lineup	Added "Crypto Assist Function"
18	4.Packages	Added the following products. S6E2CC8HHA/S6E2CC9HHA/S6E2CCAHHA/ S6E2CC8JHA/S6E2CC9JHA/S6E2CCAJHA/ S6E2CC8LHA/S6E2CC9LHA/S6E2CCALHA
212	15.ORDERING INFORMATION	Added the following part numbers. S6E2CC8HHAGV20000/S6E2CC9HHAGV20000/S6E2CCAHHAGV2000/ S6E2CC8JHAGV20000/S6E2CC9JHAGV20000/S6E2CCAJHAGV20000/ S6E2CC8JHAGB10000/S6E2CC9JHAGB10000/S6E2CCAJHAGB10000/ S6E2CC8LHAGL20000/S6E2CC9LHAGL20000/S6E2CCALHAGL20000
Revision 0.3		
1, 3	Title	Added the following products. S6E2CCAJGA /S6E2CC8JGA/S6E2CC8JFA/S6E2CCAJFA
14	2.Features	Added Voice Function
15, 16	3.Product Lineup	Added the following products. S6E2CCAJGA /S6E2CC8JGA/S6E2CC8JFA/S6E2CCAJFA
17	4.Packages	Added the following products. S6E2CCAJGA /S6E2CC8JGA/S6E2CC8JFA/S6E2CCAJFA
211	15.Ordering Information	Added the following products. S6E2CCAJGAGV20000/ S6E2CC8JGAGB10000/ S6E2CC8JFAGB10000 S6E2CCAJGAGB10000/ S6E2CCAJFAGB10000
Revision 1.0		
7 15	2. Features 3. Product Lineup	Added that CAN-FD Interface supported non-CAN FD.
12 15 90 91	2. Features 3. Product Lineup 10. Block Diagram 12. Memory Map	Deleted HDM-CEC/Remote Control Receiver.
18-20	5. Pin Assignments	Deleted the pins of HDM-CEC/Remote Control Receiver.(CEC0,CEC1) Modified the pin name of I2S. (MI2S*_0→MI2S*0_0) Deleted the pin of IGTRG0_0.
22-24	6. Pin Descriptions	Deleted the pins of HDM-CEC/Remote Control Receiver.(CEC0,CEC1) Modified the pin name of I2S. (MI2S*_0→MI2S*0_0) Modified the pin number of PF7 in LQFP216.(91→90) Modified the pin number of X1. (73, 58, 50, P5→107, 87, 71, P13) Modified the pin number of X0A. (107, 87, 71, P13→73, 58, 50, P5)
75-82	7. I/O Circuit Type	Modified IOH/IOL of Type S.(IOH=-12mA→-10mA, IOL=12mA→10mA) Added the case of using I2C in Type E, F, G, L, N, S.
97-105	13. Pin Status In Each CPU State	Deleted X and Y in Pin Status Type.
106-107	14.1. Absolute Maximum Ratings	Added 10mA type.
108-112	14.2. Recommended Operating Conditions	Added AVRL in Analog reference voltage. Modified the mistake in Ethernet-MAC Pins. Modified the leakage current in Maximum leakage current at operating
113-122	14.3.1. Current Rating	Modified the maximum current of each category.

Page	Section	Change Results
123-124	14.3.2. Pin Characteristics	Added the characteristic of external bus in H level input voltage (hysteresis input). Added the characteristic of 10mA type.
127	14.4.5. Operating Conditions of USB/Ethernet PLL · I2S PLL (in the case of using main clock for input clock of PLL)	Modified the maximum of I2S PLL macro oscillation clock frequency. (307.2MHz→384MHz)
196	14.5.12-bit A/D Converter	Modified the minimum of Sampling time. Modified the characteristic of State transition time to operation permission Added AVRL in Analog reference voltage.
204	14.8.2. Interrupt of Low-Voltage Detection	Modified the SVHI values in Conditions

NOTE: Please see “Document History” about later revised information.

Sales, Solutions, and Legal Information

Worldwide Sales and Design Support

Cypress maintains a worldwide network of offices, solution centers, manufacturer's representatives, and distributors. To find the office closest to you, visit us at [Cypress Locations](#).

Products

ARM® Cortex® Microcontrollers	cypress.com/arm
Automotive	cypress.com/automotive
Clocks & Buffers	cypress.com/clocks
Interface	cypress.com/interface
Internet of Things	cypress.com/iot
Memory	cypress.com/memory
Microcontrollers	cypress.com/mcu
PSoC	cypress.com/psoc
Power Management ICs	cypress.com/pmic
Touch Sensing	cypress.com/touch
USB Controllers	cypress.com/usb
Wireless/RF	cypress.com/wireless

PSoC® Solutions

[PSoC 1](#) | [PSoC 3](#) | [PSoC 4](#) | [PSoC 5LP](#)

Cypress Developer Community

[Forums](#) | [WICED IOT Forums](#) | [Projects](#) | [Video](#) | [Blogs](#) | [Training](#) | [Components](#)

Technical Support

cypress.com/support

ARM and Cortex are the registered trademarks of ARM Limited in the EU and other countries.

All other trademarks or registered trademarks referenced herein are the property of their respective owners.

© Cypress Semiconductor Corporation, 2014-2017. This document is the property of Cypress Semiconductor Corporation and its subsidiaries, including Spansion LLC ("Cypress"). This document, including any software or firmware included or referenced in this document ("Software"), is owned by Cypress under the intellectual property laws and treaties of the United States and other countries worldwide. Cypress reserves all rights under such laws and treaties and does not, except as specifically stated in this paragraph, grant any license under its patents, copyrights, trademarks, or other intellectual property rights. If the Software is not accompanied by a license agreement and you do not otherwise have a written agreement with Cypress governing the use of the Software, then Cypress hereby grants you a personal, non-exclusive, nontransferable license (without the right to sublicense) (1) under its copyright rights in the Software (a) for Software provided in source code form, to modify and reproduce the Software solely for use with Cypress hardware products, only internally within your organization, and (b) to distribute the Software in binary code form externally to end users (either directly or indirectly through resellers and distributors), solely for use on Cypress hardware product units, and (2) under those claims of Cypress's patents that are infringed by the Software (as provided by Cypress, unmodified) to make, use, distribute, and import the Software solely for use with Cypress hardware products. Any other use, reproduction, modification, translation, or compilation of the Software is prohibited.

TO THE EXTENT PERMITTED BY APPLICABLE LAW, CYPRESS MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARD TO THIS DOCUMENT OR ANY SOFTWARE OR ACCOMPANYING HARDWARE, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE. To the extent permitted by applicable law, Cypress reserves the right to make changes to this document without further notice. Cypress does not assume any liability arising out of the application or use of any product or circuit described in this document. Any information provided in this document, including any sample design information or programming code, is provided only for reference purposes. It is the responsibility of the user of this document to properly design, program, and test the functionality and safety of any application made of this information and any resulting product. Cypress products are not designed, intended, or authorized for use as critical components in systems designed or intended for the operation of weapons, weapons systems, nuclear installations, life-support devices or systems, other medical devices or systems (including resuscitation equipment and surgical implants), pollution control or hazardous substances management, or other uses where the failure of the device or system could cause personal injury, death, or property damage ("Unintended Uses"). A critical component is any component of a device or system whose failure to perform can be reasonably expected to cause the failure of the device or system, or to affect its safety or effectiveness. Cypress is not liable, in whole or in part, and you shall and hereby do release Cypress from any claim, damage, or other liability arising from or related to all Unintended Uses of Cypress products. You shall indemnify and hold Cypress harmless from and against all claims, costs, damages, and other liabilities, including claims for personal injury or death, arising from or related to any Unintended Uses of Cypress products.

Cypress, the Cypress logo, Spansion, the Spansion logo, and combinations thereof, WICED, PSoC, CapSense, EZ-USB, F-RAM, and Traveo are trademarks or registered trademarks of Cypress in the United States and other countries. For a more complete list of Cypress trademarks, visit cypress.com. Other names and brands may be claimed as property of their respective owners.